V89C FBGA Assembly Site Addition of PTI-Xian (CN) - Automotive / Product Longevity Program

PCN: 32351

Published: 2017-06-09

Revision History:

Revision 2, 2018-10-17: This document supersedes the original PCN #32351, dated 2017-06-09 and also the first revision dated 2017-12-22. Micron has canceled plans to stop assembly of V89C FBGA at ChipMOS (TW) and will assemble product at both ChipMOS (TW) and PTI-Xian (CN). Hence, Last Purchase and Last Shipment Dates previously provided have been removed.

Revision 1, 2017-12-22: This document supersedes the original PCN #32351, dated 2017-06-09. The Last Shipment Date has been changed from 2019-05-31 to 2018-08-31.

Туре:	Manufacturing Site – Change or Addition		
Description:	V89C FBGA SDP, currently assembled at ChipMOS TW, is being transferred to PTI-Xian. Last Time Buy and Last Time Ship Dates are included below for material assembled at ChipMOS. Site Locations: • ChipMOS Technologies, Inc. No 5 Nan-KO Rd 7 Science Based Industrial Park, Taiwan, TW		
	Reason:	Manufacturing Efficiency, Supply Flexibility/Security	
Product Affected:	V89C FBGA SDP x8/x16		
Affected Micron Part Number		Recommended Replacement	Customer Part Number
Component		-	
MT41K128M16JT-125 AAT:K			
MT41K128M16JT-125 AIT:K			
MT41K128M16JT-125 AUT:K			
MT41K128M16JT-125 M AIT:K			
MT41K128M16JT-125 V:K			
MT41K128M16JT-125 XIT:K			
MT41K256M8DA-107 AIT:K			
MT41K256M8DA-125 AAT:K			
MT41K256M8DA-125 AIT:K			
MT41K256M8DA-125 AUT:K			
		*Materials that have been ordered are in	n bold.
Method of Identification:	Country of origin on the component mark		
Micron Sites Affected:	Subcontractor		
Qualification Plan:	Will be qualified according to Micron's standard qualification processes		
Sample Available:	2017-07-04		
Qual Data Available:	2017-07-04		

NOTE: Per JEDEC Standard JESD46-C Section 3.2.3; lack of acknowledgment of this PCN within 30 days constitutes acceptance of change.

Micron Confidential and Proprietary Information

Attachments

There are no attachments on this PCN